

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

Super J MOS[®] S2 series

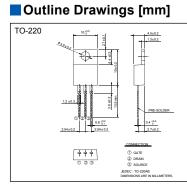
N-Channel enhancement mode power MOSFET

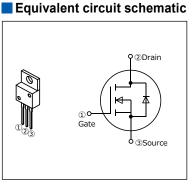
Features

Pb-free lead terminal **RoHS** compliant uses Halogen-free molding compound

Applications

For switching





Absolute Maximum Ratings at T_{vi}=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain Course Voltone	V _{DS}	600	V	
Drain-Source Voltage	VDSX	600	V	V _{GS} =-30V
Continuous Drain Current	,	47.9	А	T _{vj} =25°C Note*1,2
Continuous Drain Current	<i>I</i> _D	30.3	А	T _{vj} =100°C Note*1,2
Pulsed Drain Current	I _{DP}	148	А	Note *2
Gate-Source Voltage	V _{GS}	±30	V	
Non-Repetitive Maximum Avalanche Current	IAS	5.5	А	Note *3
Non-Repetitive Maximum Avalanche Energy	Eas	1177	mJ	Note *4
Maximum Drain-Source dV/dt	dV _{DS} /dt	50	V/ns	V _{DS} ≤ 600V
Continuous	,	47.9	А	T _{vj} =25°C Note*1,2
Diode Forward Current	Isd	30.3	А	T _{vj} =100°C Note*1,2
Pulsed Diode Forward Current	ISDP	148	А	Note *2
Peak Diode Recovery dV/dt	dV/dt	30	V/ns	Note *5
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *6
Maximum Dawar Dissinction		2.02	10/	<i>T</i> ₃=25°C
Maximum Power Dissipation	PD	270	W	<i>T</i> _{vj} =25°C
Oneverting and Stevere Temperature venue	Tch	150	°C	
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C	

Note *1 : Maximum duty cycle D=0.60

Note *1: Imited by maximum channel temperature. Note *3: T_{ch}≤150°C, See Fig.1 and Fig.2 Note *4: Starting T_{oh}=25°C, I_As=3.3A, L=198mH, V_{DD}=60V, R_G=50Ω, See Fig.1 and Fig.2 E_{AS} limited by maximum channel temperature and avalanche current. Note *5: I_{SD}≤37.1A, -di/dt≤100A/µs, V_{DS} peak≤ 600V, T_{ch}≤150°C. Note *6: I_{SD}≤37.1A, dV/dt≤30V/ns, V_{DS} peak≤ 600V, T_{ch}≤150°C.

Electrical Characteristics at T_{vj}=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{ss} =0V /₀=250µA		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I₀=5.6mA		3.0	4.0	5.0	V
Zero Gate Voltage Drain Current	loss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μA
		V _{DS} =480V V _{GS} =0V	<i>T</i> _{ch} =125°C	-	54	-	
Gate-Source Leakage Current	lass	V _{DS} =0V V _{GS} =±30V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V I₀=18.6A		-	0.073	0.084	Ω
Gate resistance	RG	f=1MHz, open drain		-	7.2	-	Ω

Dynamic Ratings

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transconductance	g _{fs}	V _{DS} =25V I _D =18.6A	12.5	25	-	S
Input Capacitance	Ciss	V _{DS} =400V	-	1950	-	
Output Capacitance	Coss	V _{GS} =0V	-	67	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	8.6	-	
Effective output capacitance, energy related (Note *7)	C _{o(er)}	V _{DS} =0400V V _{GS} =0V	-	160	-	pF
Effective output capacitance, time related (Note *8)	C _{o(tr)}	V _{DS} =0400V V _{GS} =0V I _D =constant	-	660	-	
Turn On Time	t _{d(on)}	V_{DD} =400V, V_{GS} =10V I_D =18.6A, R_G =10Ω See Fig.3 and Fig.4	-	25	-	ns
Turn-On Time	tr		-	97	-	
td(off)	t _{d(off)}		-	157	-	
Turn-Off Time	ti		-	25	-	
Total Gate Charge	QG		-	93	-	nC
Gate-Source Charge	QGS	V_{DD} =400V, V_{GS} =10V	-	31	-	
Gate-Drain Charge	QGD	_ /₀=37.1A _ See Fig.5	-	43	-	
Drain-Source crossover Charge	Qsw		-	22	-	

Note *7 : $C_{0(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V. Note *8 : $C_{0(er)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 400V.

Reverse Diode

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Diode Forward On-Voltage	V _{SD}	<i>I</i> _{SD} =37.1A, <i>V</i> _{GS} =0V <i>T</i> _{ch} =25°C	-	0.95	1.35	V
Reverse Recovery Time	trr	- V _{op} =400V, / _{sp} =37.1A -di/dt=100A/μs <i>T_c</i> h=25°C See Fig.6 and Fig.7	-	190	-	ns
Reverse Recovery Charge	Qrr		-	1.6	-	μC
Peak Reverse Recovery Current	Irp		-	16	-	А

Thermal Resistance

Parameter	Symbol	Min.	Тур.	Max.	Unit
Channel to Case	Rth(ch-c)	-	-	0.463	°C/W
Channel to Ambient	Rth(ch-a)	-	-	62	°C/W

1us ----10us

100us

1ms

1000

5

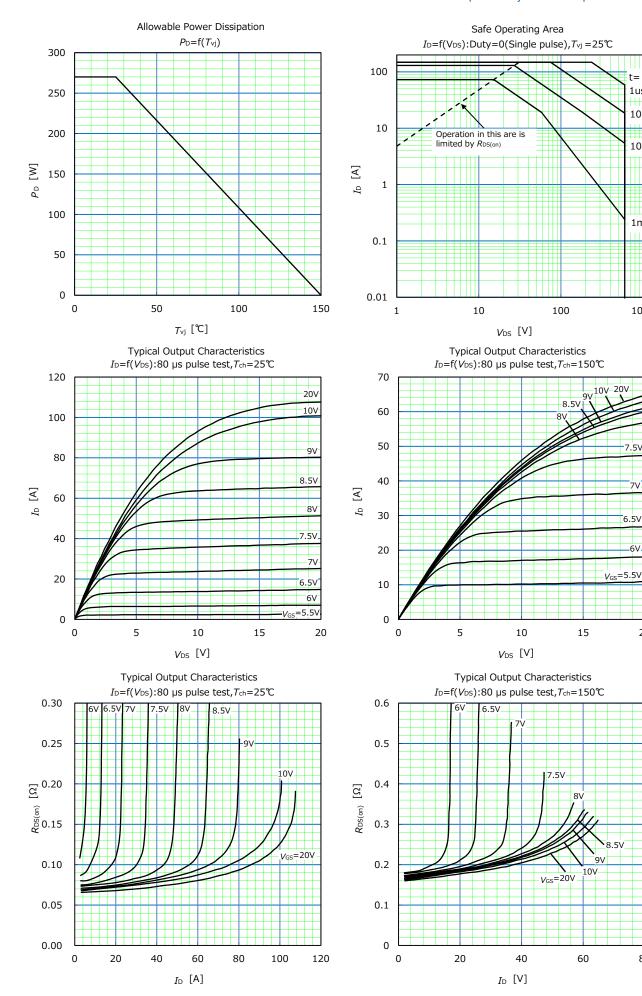
6V

20

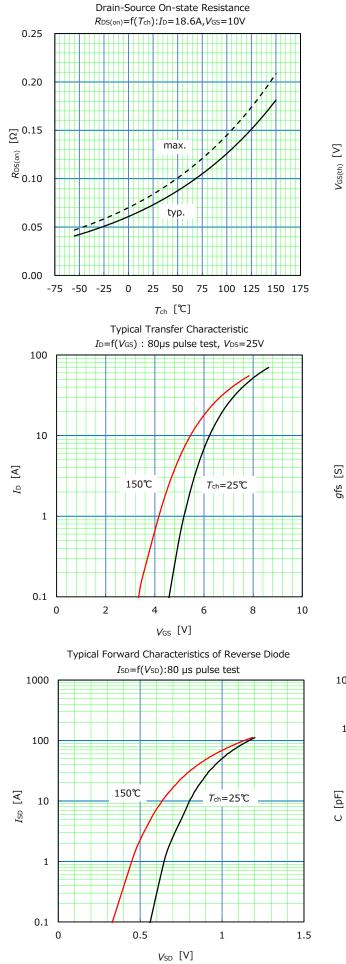
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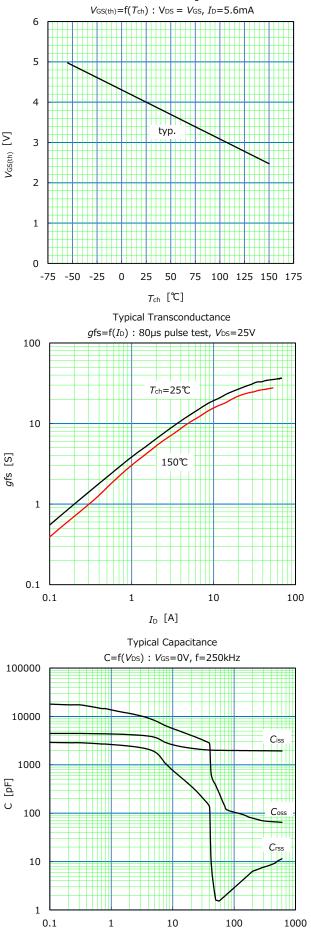
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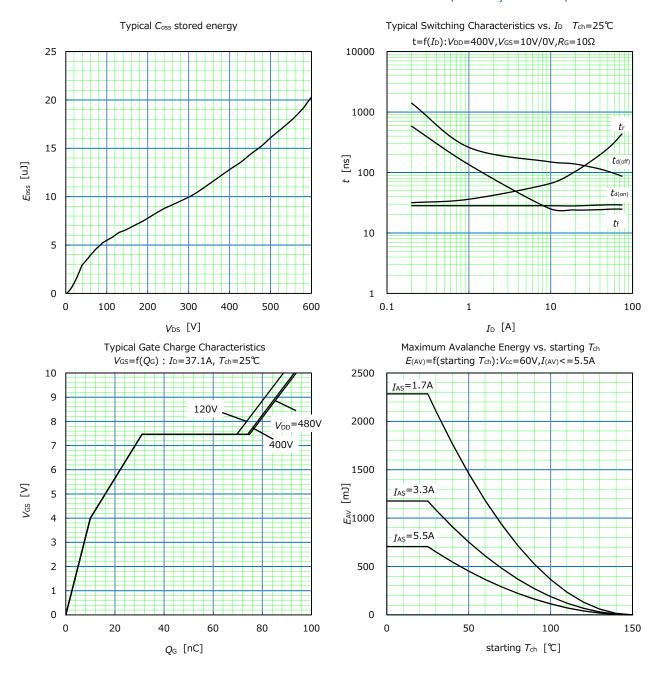


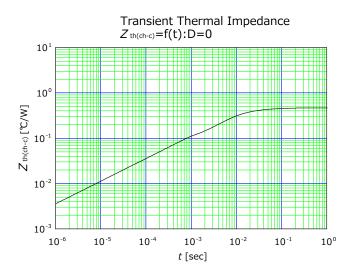
Gate Threshold Voltage vs. Tch

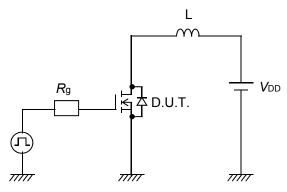


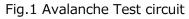


V_{DS} [V]









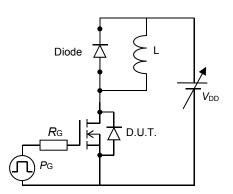


Fig.3 Switching Test circuit

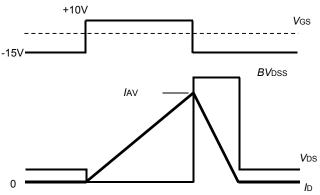


Fig.2 Operating waveforms of Avalanche Test

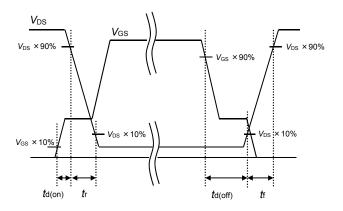


Fig.4 Operating waveform of Switching Test

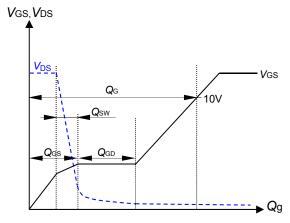
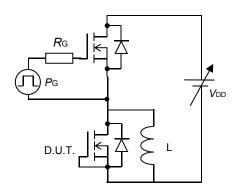


Fig.5 Operating waveform of Gate charge Test



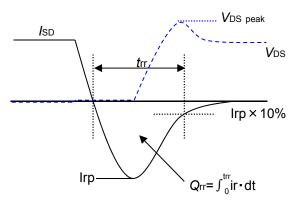
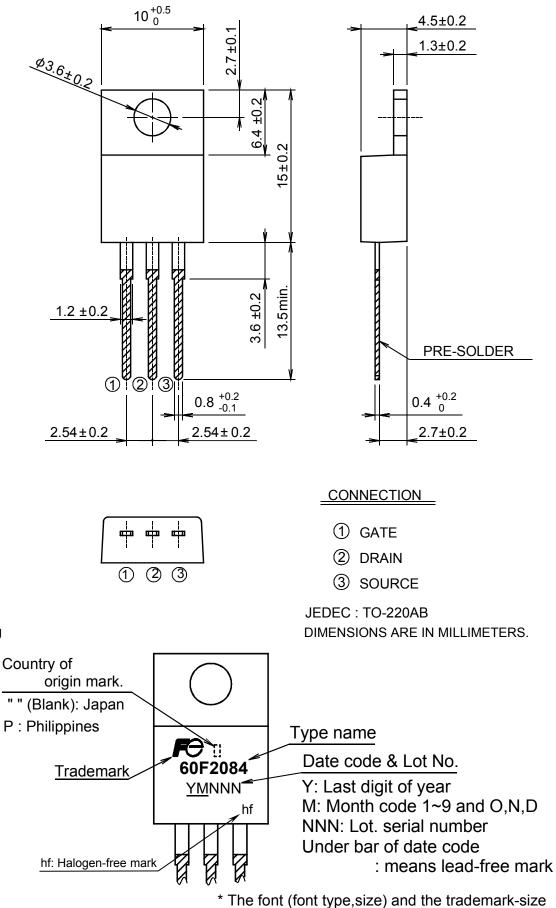


Fig.6 Reverse recovery Test circuit

Fig.7 Operating waveform of Reverse recovery Test

Outview: TO-220 Package

Marking



might be actually different.

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